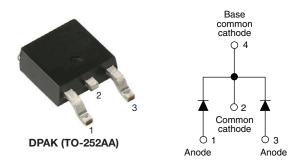


High Performance Schottky Rectifier, 2 x 6 A



PRIMARY CHARACTERISTICS					
I _{F(AV)}	2 x 6 A				
V_{R}	40 V				
V _F at I _F	0.48 V				
I _{RM}	40 mA at 125 °C				
E _{AS}	9 mJ				
T _J max.	150 °C				
Circuit configuration	Common cathode				
Package	DPAK (TO-252AA)				

FEATURES

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability



- · Center tap configuration
- · Small foot print, surface mountable
- High frequency operation
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



DESCRIPTION

The VS-12CWQ04FNHM3 surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	12	A			
V _{RRM}		40	V			
I _{FSM}	t _p = 5 μs sine	550	A			
V _F	6 A _{pk} , T _J = 125 °C (per leg)	0.48	V			
TJ	Range	-55 to +150	°C			

VOLTAGE RATINGS						
PARAMETER	SYMBOL	VS-12CWQ04FNHM3	UNITS			
Maximum DC reverse voltage	V _R	40	V			
Maximum working peak reverse voltage	V_{RWM}	40	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	per leg	_	50 % duty cycle at T _C = 134 °C, rectangular waveform		6	А
See fig. 5	per device	I _{F(AV)}			12	
Maximum peak one cycle		I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with	550	А
See fig. 7	non-repetitive surge current See fig. 7		10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	90	
Non-repetitive avalanche ene	rgy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 1.5 A, L = 8 mH		9	mJ
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		1.2	Α



ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS			
		6 A	- T _{.1} = 25 °C	0.53	V		
Maximum forward	V (1)	12 A	1]=25 0	0.68			
voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	6 A	- T _{.I} = 125 °C	0.48			
		12 A	- IJ = 125 C	0.64			
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C		3	mA		
See fig. 2	I IRM \ /	T _J = 125 °C	V _R = rated V _R	40	IIIA		
Threshold voltage	V _{F(TO)}	- T _J = T _J maximum		0.28	V		
Forward slope resistance	r _t			25.58	mΩ		
Typical junction capacitance per leg	C _T	V _R = 5 V _{DC} (test signal ran	405	pF			
Typical series inductance per leg	L _S	Measured lead to lead 5 i	5.0	nH			

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C	
Maximum thermal resistance,	per leg	В	DC operation	3.0	°C/W	
junction to case	per device	R_{thJC}	See fig. 4	1.5	C/ VV	
Approximate weight				0.3	g	
Approximate weight				0.01	OZ.	
Marking device			Case style DPAK (TO-252AA)	12CWC	04FNH	

Note

(1)
$$\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$$
 thermal runaway condition for a diode on its own heatsink



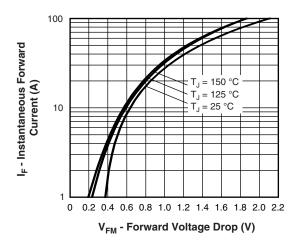


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

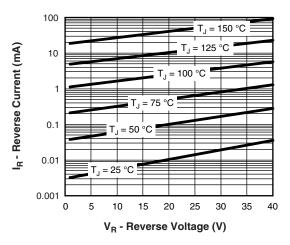


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

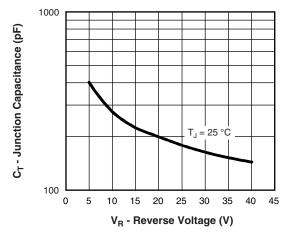


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

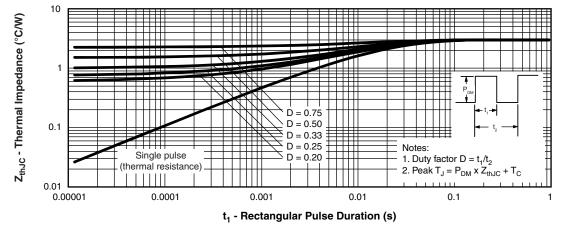


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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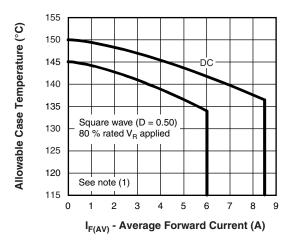


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

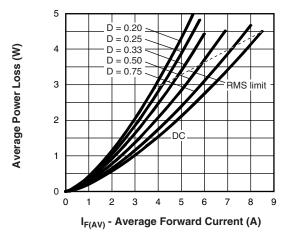


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

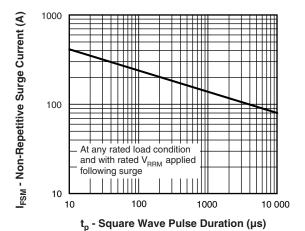


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

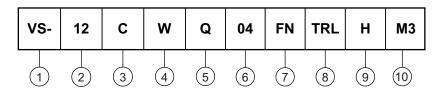
Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = 80 \text{ \% rated } V_R \\ \end{array}$



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (12 A)

Center tap configuration

4 - Package identifier:

W = DPAK

5 - Schottky "Q" series

Voltage rating (04 = 40 V)

7 - FN = TO-252AA

8 - • None = Tube

• TR = Tape and reel

• TRL = Tape and reel (left oriented)

• TRR = Tape and reel (right oriented)

9 - H = AEC-Q101 qualified

10 - Environmental digit:

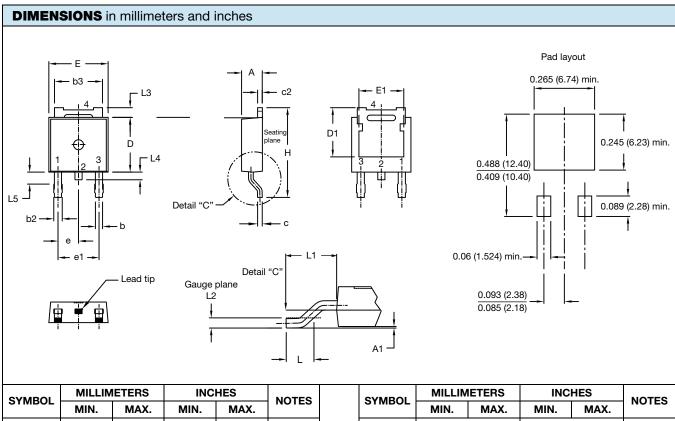
M3 = Halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-12CWQ04FNHM3	75	3000	Antistatic plastic tube			
VS-12CWQ04FNTRHM3	2000	2000	13" diameter reel			
VS-12CWQ04FNTRRHM3	3000	3000	13" diameter reel			
VS-12CWQ04FNTRLHM3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95519			
Part marking information	www.vishay.com/doc?95518			
Packaging information	www.vishay.com/doc?95033			
SPICE model	www.vishay.com/doc?97045			



DPAK (TO-252AA)



SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	4.93	-	0.194	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIM	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	2.29 BSC		BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108	REF.	
L2	0.51	0.51 BSC		BSC	
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA, except for D1 dimension



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